

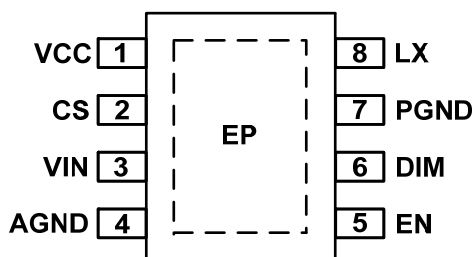
Ordering Information ⁽¹⁾

Part Number	Marking	Junction Temperature Range	Package	PWM
MIC3202YME	MIC3202YME	-40°C to +125°C	8-Pin SOIC	Dither
MIC3202-1YME	MIC3202-1YME	-40°C to +125°C	8-Pin SOIC	Non-Dither

Note:

1. YM[®] is a GREEN RoHS-compliant package. Lead finish is NiPdAu. Mold compound is Halogen Free.

Pin Configuration



8-Pin ePAD SOIC
MIC3202/MIC3202-1

Pin Description

Pin Number	Pin Name	Pin Function
1	VCC	Voltage Regulator Output. The VCC pin supplies the power to the internal circuitry. The VCC is the output of a linear regulator which is powered from VIN. A 1µF ceramic capacitor is recommended for bypassing and should be placed as close as possible to the VCC and AGND pins.
2	CS	Current-Sense Input. The CS pin provides the high-side current sense to set the LED current using an external sense resistor.
3	VIN	Input Power Supply. The VIN pin is the input supply pin to the internal circuitry and the positive input to the current sense comparator. Due to the high frequency switching noise, a 1µF ceramic capacitor is recommended to be placed as close as possible to VIN pin and the power ground (PGND) pin for bypassing. Please refer to layout recommendations.
4	AGND	Ground pin for analog circuitry. Internal signal ground for all low power sections.
5	EN	Enable Input. The EN pin provides a logic level control of the output. The voltage has to be 2.0V or higher to enable the current regulator. The output stage is also gated by the DIM input. When the EN pin is pulled low, the regulator goes to off state and the supply current of the device is greatly reduced (below 1µA).
6	DIM	PWM Dimming Input. The DIM pin provides the control for brightness of the LED. A PWM input can be used to control the brightness of LED. DIM high enables the output and its voltage has to be at least 2.0V or higher. DIM low disables the output, regardless of EN "high" state.
7	PGND	Power Ground pin for Internal Power FET. Power Ground (PGND) is the ground path for the high current. The current loop for the power ground should be as small as possible and separate from the Analog ground (AGND) loop. Refer to the layout considerations for more details.
8	LX	Drain of Internal Power MOSFET. The LX pin connects directly to the inductor and provides the switching current necessary to operate in hysteretic mode. Due to the high frequency switching and high voltage associated with this pin, the switch node should be routed away from sensitive nodes.
EP	GND	Connect to PGND.

Absolute Maximum Ratings ^(1, 2)

V_{IN} to PGND	-0.3V to +42V
V_{LX} to PGND	-0.3V to ($V_{IN} + 0.6V$)
V_{CS} to PGND	-0.3V to ($V_{IN} + 0.3V$)
V_{EN} to AGND	-0.3V to ($V_{IN} + 0.3V$)
V_{DIM} to AGND	-0.3V to ($V_{IN} + 0.3V$)
V_{CC} to PGND	-0.3V to +6.0V
PGND to AGND	-0.3V to +0.3V
Junction Temperature	150°C
Storage Temperature Range	-60°C to +150°C
Lead Temperature (Soldering, 10sec)	260°C

Operating Ratings ⁽³⁾

Supply Voltage (V_{IN})	6.0V to 37V
Enable Voltage (V_{EN})	0V to V_{IN}
Dimming Voltage (V_{DIM})	0V to V_{IN}
Junction Temperature (T_J)	-40°C to +125°C
Junction Thermal Resistance	
SOIC (θ_{JA})	41°C/W
SOIC (θ_{JC})	14.7°C/W

Electrical Characteristics ⁽⁴⁾

$V_{IN} = V_{EN} = V_{DIM} = 12V$; $C_{VCC} = 1.0\mu F$; $T_J = 25^\circ C$, **bold** values indicate $-40^\circ C \leq T_J \leq +125^\circ C$; unless noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Input Supply						
V_{IN}	Input Voltage Range (V_{IN})		6.0		37.0	V
I_S	Supply Current	LX Pin = open		1.2	1.75	mA
I_{SD}	Shut Down Current	$V_{EN} = 0V$; $T_J =$ from $-40^\circ C$ to $85^\circ C$		0.05	5	μA
UVLO	V_{IN} UVLO Threshold	V_{IN} Rinsing	3.2	4	4.5	V
UVLO _{HYS}	V_{IN} UVLO Hysteresis			500		mV
VCC Supply						
VCC	V_{CC} Output Voltage	$V_{CS} = V_{IN} = 12V$, $I_{CC} = 10mA$	4.5	5	5.5	V
Current Limit						
$V_{CS(MAX)}$	Current-Sense Upper Threshold	$V_{CS(MAX)} = V_{IN} - V_{CS}$	199	212	225	mV
$V_{CS(MIN)}$	Current-Sense Lower Threshold	$V_{CS(MIN)} = V_{IN} - V_{CS}$	165	177	189	mV
V_{CSHYS}	V_{CS} Hysteresis			35		mV
	Current-Sense Response Time	V_{CS} Rising		60		ns
		V_{CS} Falling		40		
	Current-Sense Input Current	$V_{IN} - V_{CS} = 200mV$			3	μA
Frequency						
F_{MAX}	Maximum Switching Frequency				1	MHz
Dithering (MIC3202)						
V_{DITH}	V_{CS} Hysteresis Dithering Range ⁽⁵⁾			± 6		mV
F_{DITHER}	Frequency Dithering Range ⁽⁵⁾	% of Switching Frequency		± 12		%
Enable Input						
EN_{HI}	EN Logic Level High		2.0			V
EN_{LO}	EN Logic Level Low				0.4	V
	EN Bias Current	$V_{EN} = 12V$		30	60	μA
		$V_{EN} = 0V$		0.1	1	
	Start-up Time	From EN Pin going high to LX going low		30		μs

Electrical Characteristics ⁽⁴⁾

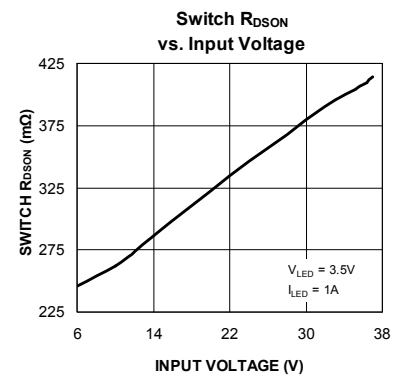
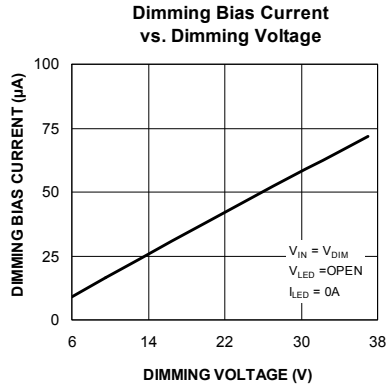
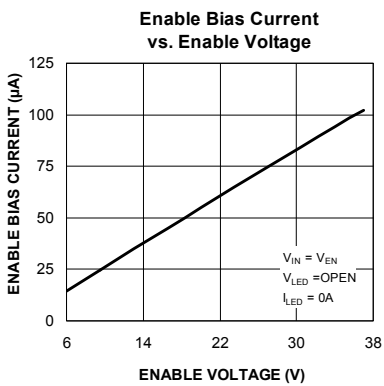
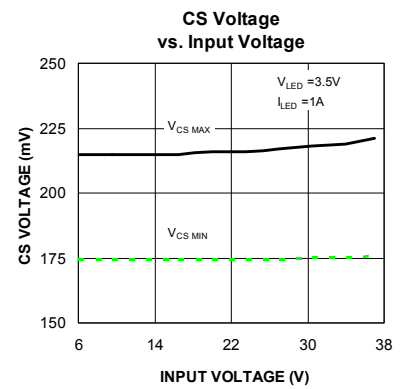
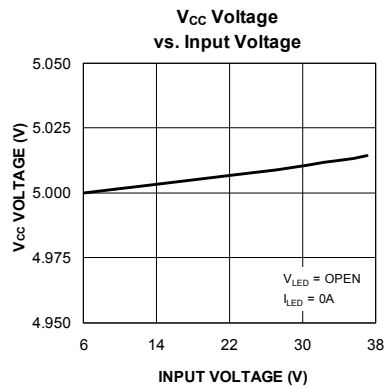
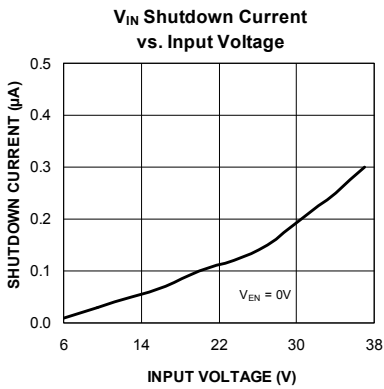
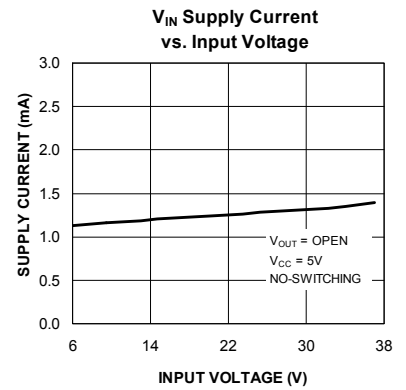
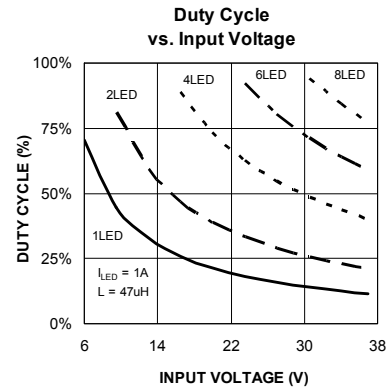
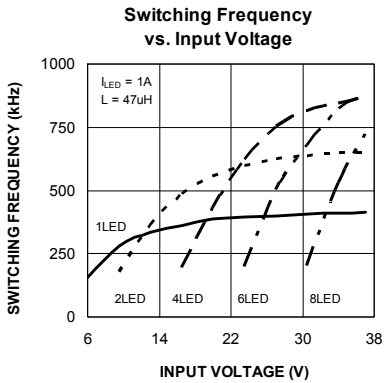
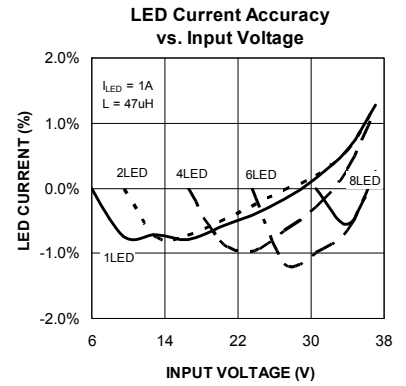
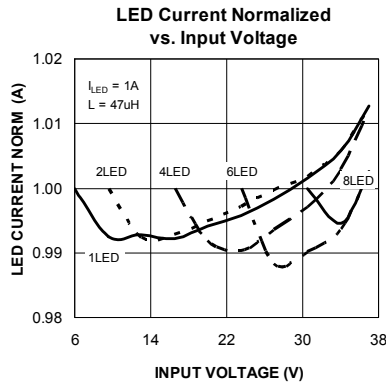
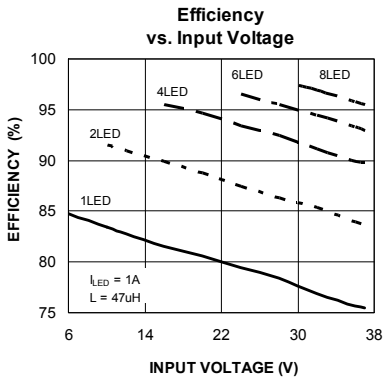
$V_{IN} = V_{EN} = V_{DIM} = 12V$; $C_{VCC} = 1.0\mu F$; $T_J = 25^\circ C$, bold values indicate $-40^\circ C \leq T_J \leq +125^\circ C$; unless noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Dimming Input						
DIM _{HI}	DIM Logic Level High		2.0			V
DIM _{LO}	DIM Logic Level Low				0.4	V
	DIM Bias Current	$V_{DIM} = 12V$		20	35	μA
$V_{DIM} = 0V$			0.1	1		
f _{DIM}	Maximum Dimming Frequency				20	kHz
Internal MOSFET						
R _{DS(ON)}	MOSFET R _{DS(ON)}	$I_{LX} = 200mA$		275	625	m Ω
	LX Leakage Current	$V_{EN} = 0V$; $V_{IN} = V_{LX} = 37V$		5	50	μA
Thermal Protection						
T _{LIM}	Over-Temperature Shutdown	T _J Rising		160		$^\circ C$
T _{LIMHYS}	Over-Temperature Shutdown Hysteresis			20		

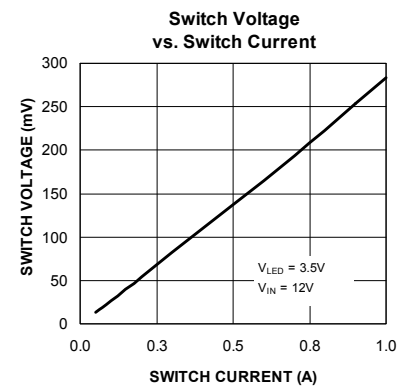
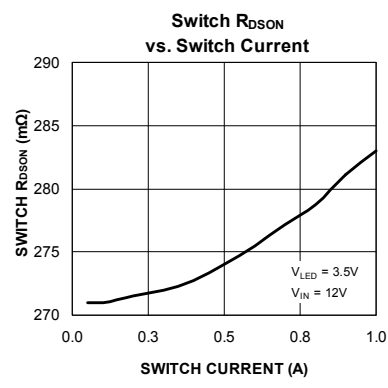
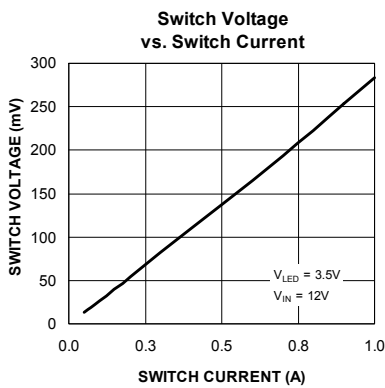
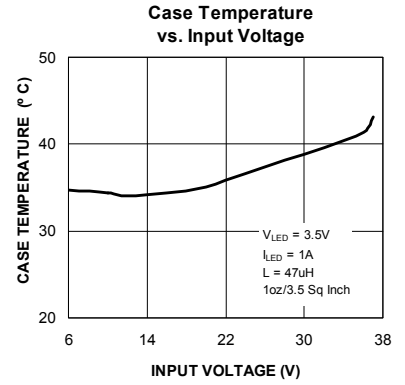
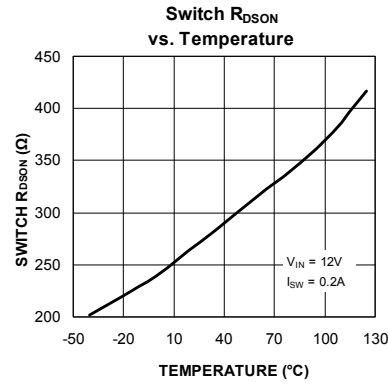
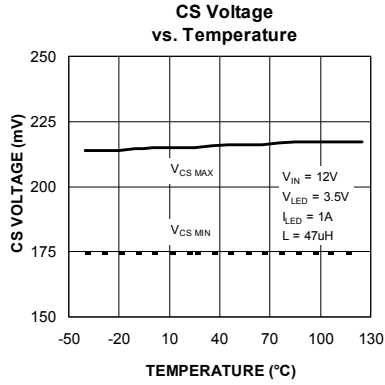
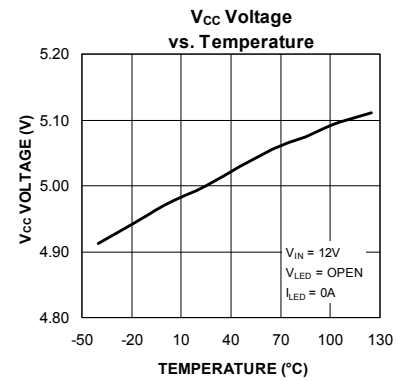
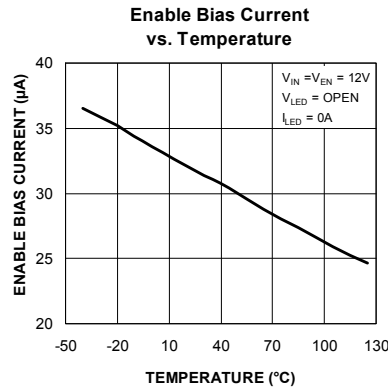
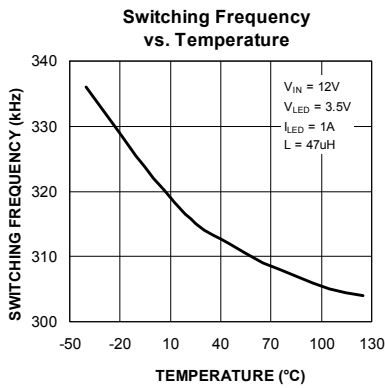
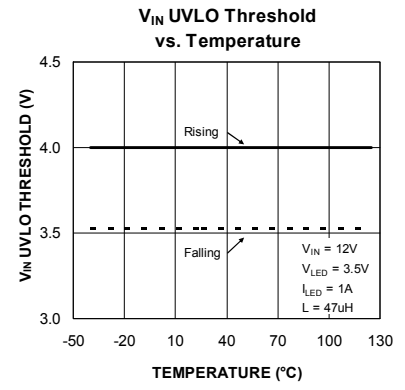
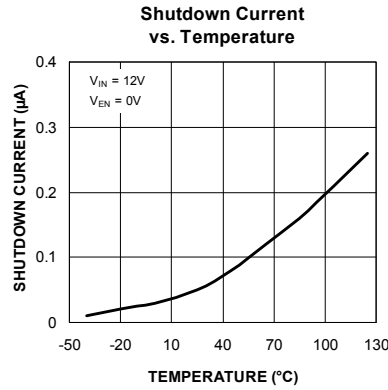
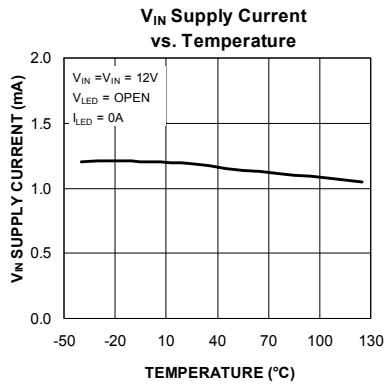
Notes:

1. Exceeding the absolute maximum rating may damage the device.
2. Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5k in series with 100pF.
3. The device is not guaranteed to function outside its operating rating.
4. Specification for packaged product only.
5. Guaranteed by design.

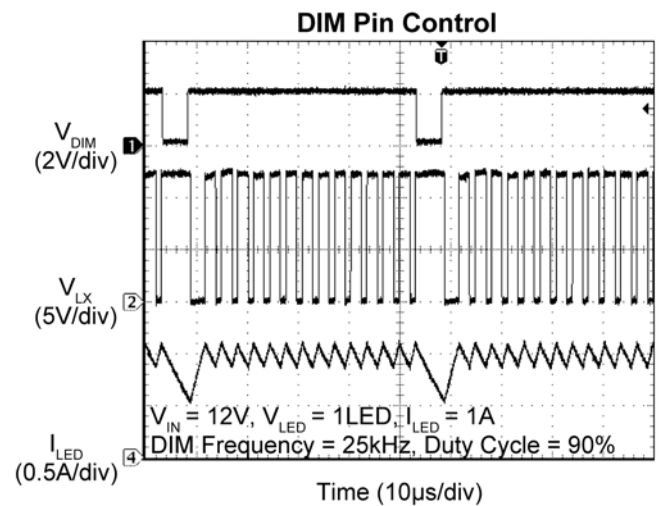
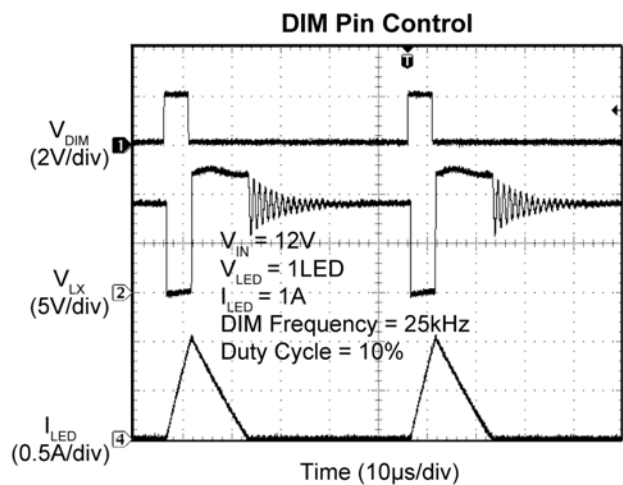
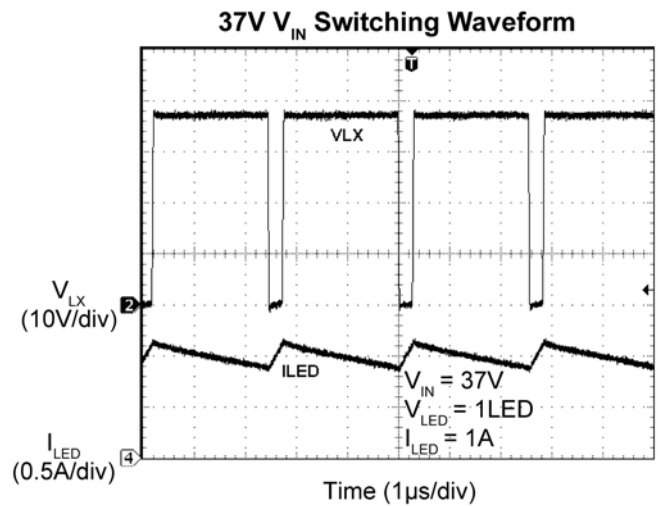
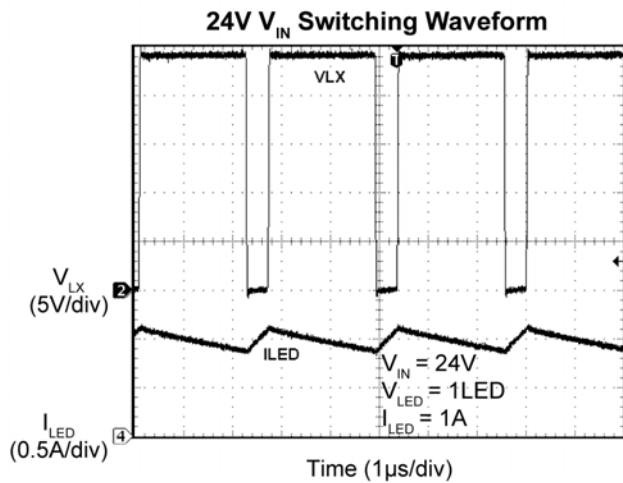
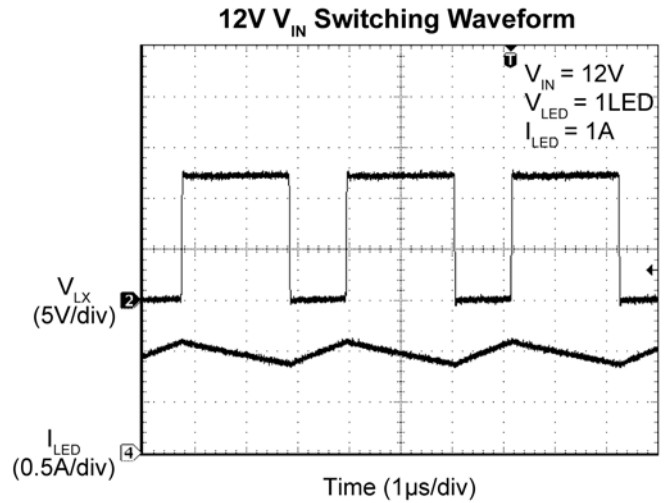
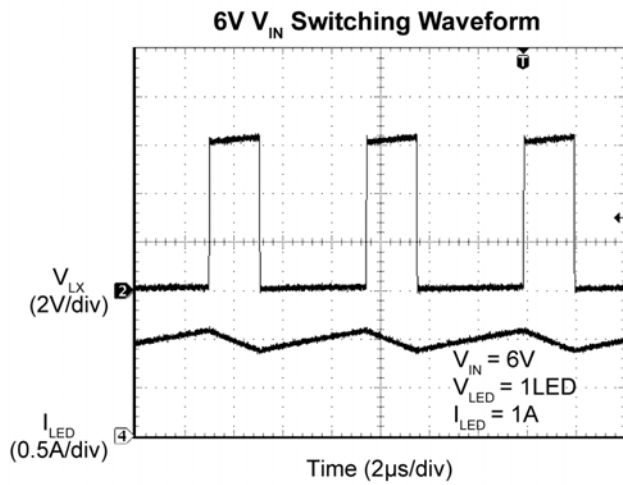
Typical Characteristics



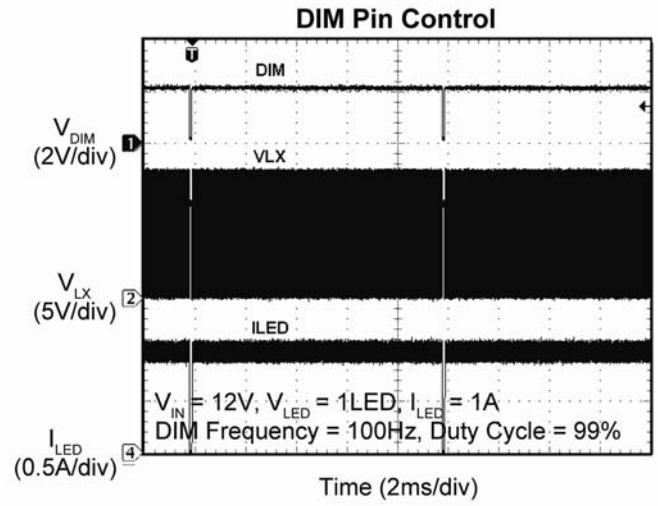
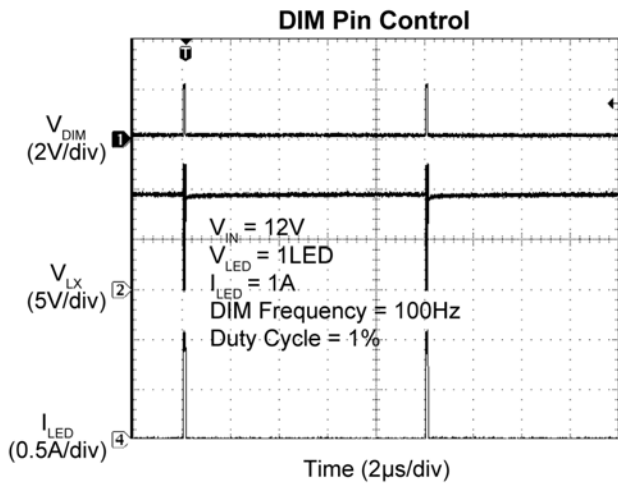
Typical Characteristics (Continued)



Functional Characteristics



Functional Characteristics (Continued)



Functional Diagram

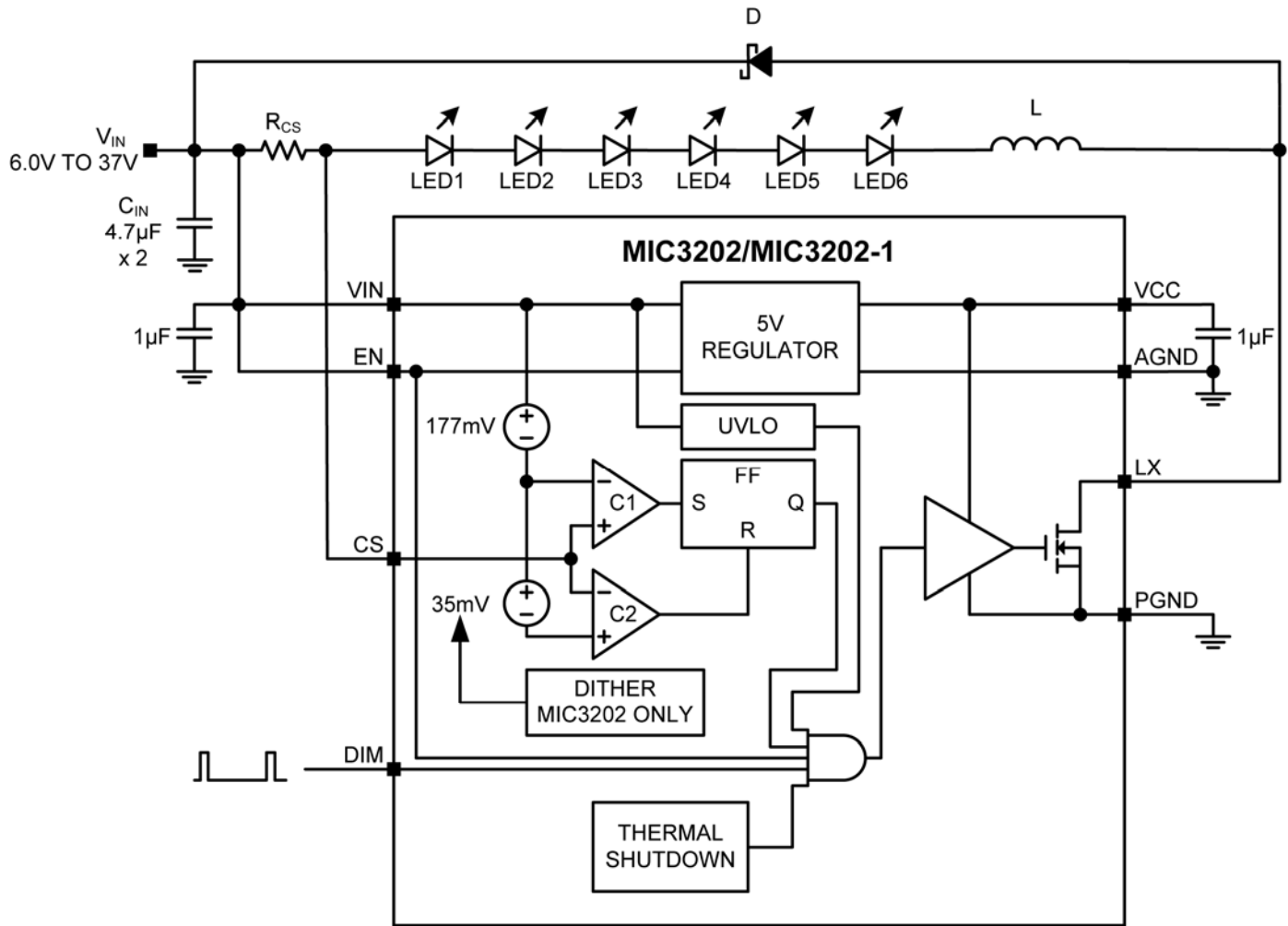


Figure 1. MIC3202/MIC3202-1 Functional Block Diagram

Functional Description

The MIC3202 is a hysteretic step-down driver which regulates the LED current over wide input voltage range and capable of driving up to eight 1A LEDs in series.

The device operates from a 6V to 37V input. When the input voltage reaches 6V, the internal 5V VCC is regulated and the LX pin is pulled low if the EN pin and DIM pin are high. The inductor current builds up linearly. When the CS pin voltage hits $V_{CS(MAX)}$ with respect to V_{IN} , the MOSFET turns off and the Schottky diode takes over and returns the current to V_{IN} . Then the current through inductor and LEDs starts decreasing. When CS pin hits $V_{CS(MIN)}$, the MOSFET turns on and the cycle repeats.

The frequency of operation depends upon the input voltage, total LED voltage drop, LED current and temperature. The calculation for frequency of operation is given in the *Application Information* section.

The MIC3202 has an EN pin which gives the flexibility to enable and disable the output with logic high and low signals.

The MIC3202 also has a DIM pin which can turn on and off the LEDs if EN is in HIGH state. This DIM pin controls the brightness of the LED by varying the duty cycle of DIM pin from 1% to 99%.

Application Information

The internal block diagram of the MIC3202 is shown in Figure 1. The MIC3202 is composed of a current-sense comparator, voltage and current reference, 5V regulator and MOSFET. Hysteretic mode control, also called bang-bang control, is a topology that does not employ an error amplifier, using an error comparator instead.

The inductor current is controlled within a hysteretic window. If the inductor current is too small, the power MOSFET is turned on; if the inductor current is large enough, the power MOSFET is turned off. It is a simple control scheme with no oscillator and no loop compensation. Since the control scheme does not need loop compensation, it simplifies design and avoids problems of instability.

Transient response to load and line variation is very fast and only depends on propagation delay. This makes the control scheme very popular to achieve low dimming duty cycles.

LED Current and R_{CS}

The main function of the MIC3202 is to control the LED current accurately within $\pm 5\%$ of the set current. A high-side R_{CS} resistor sets LED current. The following equation gives the R_{CS} value:

$$R_{CS} = \frac{1}{2} \times \left(\frac{V_{CS(MAX)} + V_{CS(MIN)}}{I_{LED}} \right)$$

R_{CS} (Ω)	I_{LED} (A)	I^2R (W)	Size (SMD)
1.33	0.15	0.03	0603
0.56	0.35	0.07	0805
0.4	0.5	0.1	0805
0.28	0.7	0.137	0805
0.2	1.0	0.2	1206

Table 1. R_{CS} Values for Various LED Currents

For $V_{CS(MAX)}$ and $V_{CS(MIN)}$, refer to the Electrical Characteristic table.

Frequency of Operation

To calculate the frequency spread across input supply:

$$V_L = L \frac{\Delta I_L}{\Delta t}$$

L is the inductance, ΔI_L is fixed (the value of the hysteresis):

$$\Delta I_L = \frac{V_{CS(MAX)} - V_{CS(MIN)}}{R_{CS}}$$

V_L is the voltage across inductor L which varies by supply.

For current rising (MOSFET is ON):

$$t_r = L \frac{\Delta I_L}{V_{L_RISE}}$$

where:

$$V_{L_RISE} = V_{IN} - I_{LED} \times R_{CS} - V_{LED}$$

For current falling (MOSFET is OFF):

$$t_f = L \frac{\Delta I_L}{V_{L_FALL}}$$

where:

$$V_{L_FALL} = V_D + I_{LED} \times R_{CS} + V_{LED}$$

$$T = t_r + t_f, f_{SW} = \frac{1}{T}$$

$$f_{SW} = \frac{(V_D + I_{LED} \times R_{CS} + V_{LED}) \times (V_{IN} - I_{LED} \times R_{CS} - V_{LED})}{L \times \Delta I_L \times (V_D + V_{IN})}$$

where:

V_D is Schottky diode forward drop.

V_{LED} is total LEDs voltage drop.

V_{IN} is input voltage.

I_{LED} is average LED current.

Inductor

According to the above equation, choose the inductor to make the operating frequency no higher than 1.0MHz. Tables 2, 3, and 4 give a reference inductor value and corresponding frequency for a given LED current. For space-sensitive applications, smaller inductor with higher switching frequency could be used but the efficiency of the regular will be reduced.

RCS (Ω)	I _{LED} (A)	L (μH)	F _{SW} (kHz)
1.33	0.15	220	474
0.56	0.35	100	439
0.4	0.5	68	461
0.28	0.7	47	467
0.2	1.0	33	475

Table 2. Inductor for V_{IN} = 12V, 1 LED

RCS (Ω)	I _{LED} (A)	L (μH)	F _{SW} (kHz)
1.33	0.15	470	474
0.56	0.35	220	426
0.4	0.5	150	447
0.28	0.7	100	470
0.2	1.0	68	493

Table 3. Inductor for V_{IN} = 24V, 4 LEDs

RCS (Ω)	I _{LED} (A)	L (μH)	F _{SW} (kHz)
1.33	0.15	470	495
0.56	0.35	220	446
0.4	0.5	150	467
0.28	0.7	100	490
0.2	1.0	68	515

Table 4. Inductor for V_{IN} = 36V, 8 LEDs

Given an inductor value, the size of the inductor can be determined by its RMS and peak current rating.

$$\frac{\Delta I_L}{I_L} = 2 \times \frac{V_{CS(MAX)} - V_{CS(MIN)}}{V_{CS(MAX)} + V_{CS(MIN)}} = 0.18$$

$$I_{L(RMS)} = \sqrt{I_L^2 + \frac{1}{12} \Delta I_L^2} \approx I_L$$

$$I_{L(PK)} = I_L + \frac{1}{2} \Delta I_L = 1.09 I_L$$

where:

I_L is inductor average current.

Select an inductor with saturation current rating at least 30% higher than the peak current.

Free-Wheeling Diode

The free-wheeling diode should have the reverse voltage rating to accommodate the maximum input voltage. The forward voltage drop should be small to get the lowest conduction dissipation for high efficiency. The forward current rating has to be at least equal to LED current. A Schottky diode is recommended for highest efficiency.

Input Capacitor

The ceramic input capacitor is selected by voltage rating and ripple current rating. To determine the input current ripple rating, the RMS value of the input capacitor can be found by:

$$I_{CIN(RMS)} = I_{LED} \times \sqrt{D \times (1-D)}$$

The power loss in the input capacitor is:

$$P_{LOSS(CIN)} = I_{CIN(RMS)}^2 \times C_{IN(ESR)}$$

The input capacitor current rating can be considered as I_{LED}/2 under the worst condition D = 50%.

LED Ripple Current

The LED current is the same as inductor current. If LED ripple current needs to be reduced then place a 4.7μF/50V ceramic capacitor across LED.

Frequency Dithering

The MIC3202 is designed to reduce EMI by dithering the switching frequency ±12% in order to spread the noise spectrum over a wider range. This lowers the EMI noise peaks generated by the switching regulator.

Switching regulators generate noise by their nature and they are the main EMI source to interference with nearby circuits. If the switching frequency of a regulator is modulated via frequency dithering, the energy of the EMI is spread among many frequencies instead of concentrated at fundamental switching frequency and its harmonics. The MIC3202 modulates the V_{CS(MAX)} with amplitude ±6mV by a pseudo random generator to generate the ±12% of the switching frequency dithering to reduce the EMI noise peaks.

PCB Layout Guidelines

Warning!!! To minimize EMI and output noise, follow these layout recommendations.

PCB Layout is critical to achieve reliable, stable and efficient performance. A ground plane is required to control EMI and minimize the inductance in power, signal and return paths.

The following guidelines should be followed to insure proper operation of the MIC3202 regulator.

IC

Use thick traces to route the input and output power lines.

Signal and power grounds should be kept separate and connected at only one location.

Input Capacitor

Place the input capacitors on the same side of the board and as close to the IC as possible.

Keep both the VIN and PGND traces as short as possible.

Place several vias to the ground plane close to the input capacitor ground terminal, but not between the input capacitors and IC pins.

Use either X7R or X5R dielectric input capacitors. Do not use Y5V or Z5U type capacitors.

Do not replace the ceramic input capacitor with any other type of capacitor. Any type of capacitor can be placed in parallel with the input capacitor.

If a Tantalum input capacitor is placed in parallel with the input capacitor, it must be recommended for switching regulator applications and the operating voltage must be derated by 50%.

In "Hot-Plug" applications, a Tantalum or Electrolytic bypass capacitor must be placed in parallel to ceramic capacitor to limit the over-voltage spike seen on the input supply with power is suddenly applied. In this case an additional Tantalum or Electrolytic bypass input capacitor of 22 μ F or higher is required at the input power connection if necessary.

Inductor

Keep the inductor connection to the switch node (LX Pin) short.

Do not route any digital lines underneath or close to the inductor.

To minimize noise, place a ground plane underneath the inductor.

Output Capacitor

If LED ripple current needs to be reduced then place a 4.7 μ F/50V capacitor across LED. The capacitor must be placed as close to the LED as possible.

Diode

Place the Schottky diode on the same side of the board as the IC and input capacitor.

The connection from the Schottky diode's Anode to the switching node must be as short as possible.

The diode's Cathode connection to the R_{CS} must be kept as short as possible.

RC Snubber

Place the RC snubber on the same side of the board and as close to the Schottky diode as possible. Also the snubber closest to LX pin and PGND pin.

R_{CS} (Current-Sense Resistor)

Make a Kelvin connection to the VIN and CS pins respectively for current sensing.

Trace Routing Recommendation

Keep the power traces as short and wide as possible. One current flowing loop is during the internal MOSFET ON time, the traces connecting the input capacitor C_{IN}, R_{CS}, LEDs, Inductor, the LX pin, PGND and back to C_{IN}. The other current flowing loop is during the internal MOSFET OFF time, the traces connecting R_{CS}, LED, inductor, free wheeling diode and back to R_{CS}. These two loop areas should be kept as small as possible to minimize the noise interference,

Keep all analog signal traces away from the switching node and its connecting traces.

Ripple Measurements

To properly measure ripple on either input or output of a switching regulator, a proper ring in tip measurement is required. Standard oscilloscope probes come with a grounding clip, or a long wire with an alligator clip. Unfortunately, for high-frequency measurements, this ground clip can pick-up high-frequency noise and erroneously inject it into the measured output ripple.

The standard evaluation board accommodates a home made version by providing probe points for both the input and output supplies and their respective grounds. This requires the removing of the oscilloscope probe sheath and ground clip from a standard oscilloscope probe and wrapping a non-shielded bus wire around the oscilloscope probe. If there does not happen to be any non-shielded bus wire immediately available, the leads from axial resistors will work. By maintaining the shortest possible ground lengths on the oscilloscope probe, true ripple measurements can be obtained.



Figure 2. Low-Noise Measurement

Evaluation Board Schematic

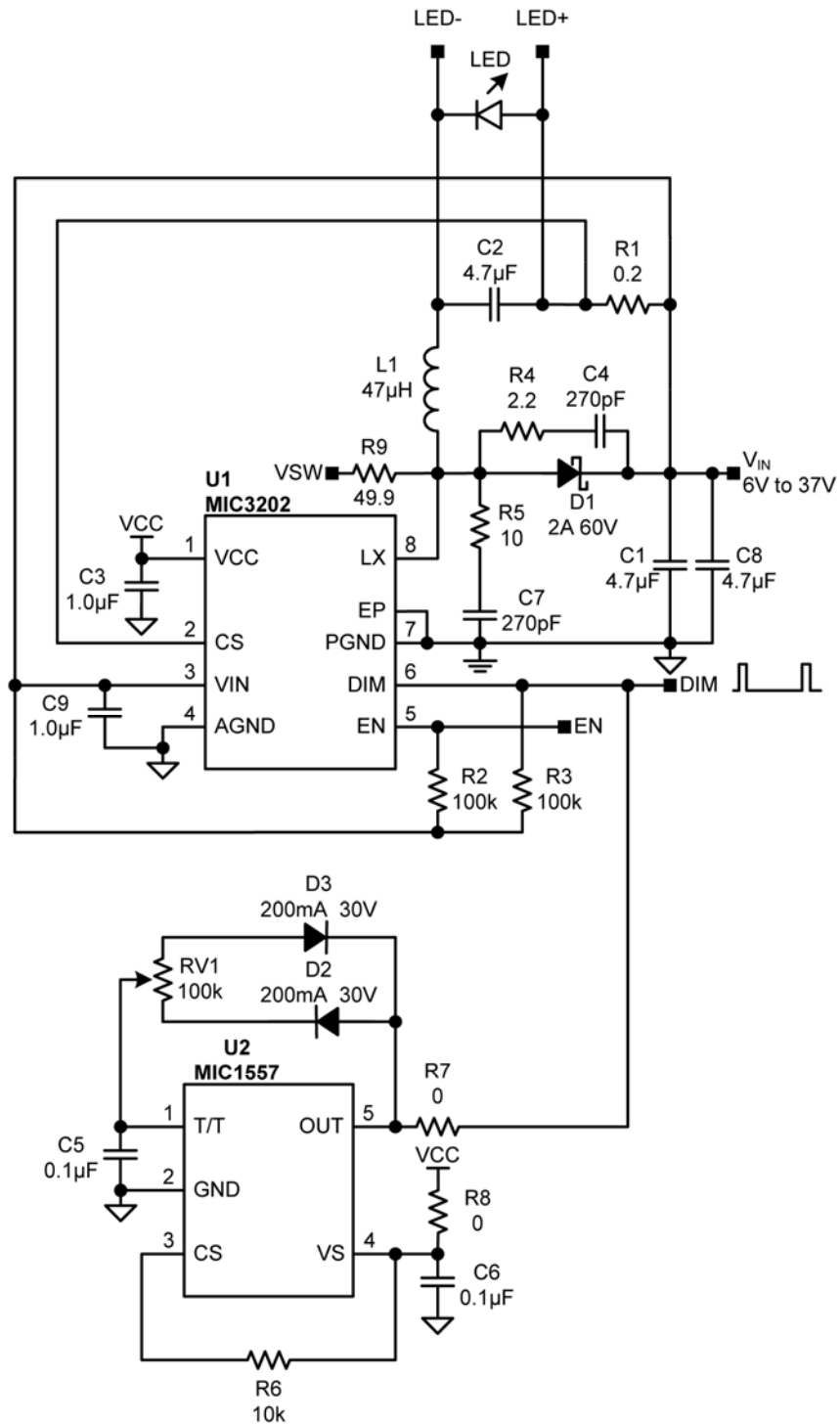


Figure 3. MIC3202 Application Circuit
(R9 is for test purposes only)

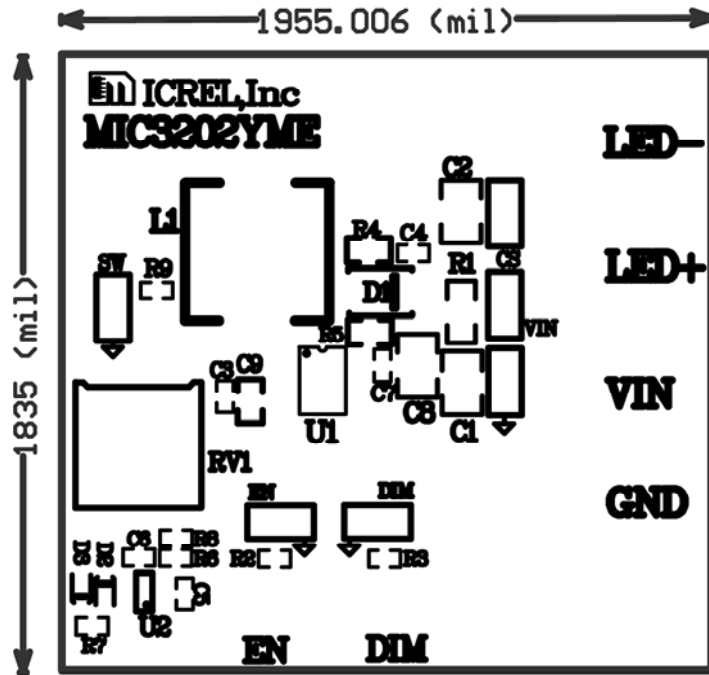
Bill of Materials

Item	Part Number	Manufacturer	Description	Qty.
C1, C2, C8	12105C475KAZ2A	AVX ⁽¹⁾	4.7µF/50V, Ceramic Capacitor, X7R, Size 1210	2
	GRM32ER71H475KA88L	Murata ⁽²⁾		
C3, C9	08053D105KAT2A	AVX ⁽¹⁾	1µF/25V, Ceramic Capacitor, X5R, Size 0805	1
	GRM21BR71E105KA99L	Murata ⁽²⁾		
	C2012X7R1E105K	TDK ⁽³⁾		
C4, C7	06035C271KAT2A	AVX ⁽¹⁾	270pF/50V, Ceramic Capacitor NPO, Size 0603	2
	GRM188R71H271KA01D	Murata ⁽²⁾		
C5, C6	06035C104MAT	AVX ⁽¹⁾	0.1µF/50V, Ceramic Capacitor, X7R, Size 0603	2
	GRM188R71H104KA93D	Murata ⁽²⁾		
	C1608X7R1H104K	TDK ⁽³⁾		
D1	SS24-TP	MCC ⁽⁴⁾	60V, 2A, SMA, Schottky Diode	1
	SS24	Fairchild ⁽⁵⁾		
D2, D3	B0530WS-TP	MCC ⁽⁴⁾	30V, 200mA, Schottky diode, SOD-323	2
L1	SLF10145T-470M1R4	TDK ⁽³⁾	47µH, 1.4A, SMT, Power Inductor	1
R1	CSR 1/2 0.2 1% I	Stackpole Electronics, Inc ⁽⁷⁾	0.2Ω Resistor, 1/2W, 1%, Size 1206	1
R2, R3	CRCW06031003FKEA	Vishay ⁽⁸⁾	100kΩ Resistor, 1%, Size 0603	2
R4	CRCW08052R20FKEA	Vishay ⁽⁸⁾	2.2Ω Resistor, 1%, Size 0805	1
R5	CRCW080510R0FKEA	Vishay ⁽⁸⁾	10Ω Resistor, 1%, Size 0805	1
R6	CRCW060310K0FKEA	Vishay ⁽⁸⁾	10kΩ Resistor, 1%, Size 0603	1
R7, R8	CRCW06030000FKEA	Vishay ⁽⁸⁾	0Ω Resistor, 1%, Size 0603	2
R9	CRCW060349R9FKEA	Vishay ⁽⁸⁾	49.9Ω Resistor, 1%, Size 0603	1
RV1	3386P-1-104TLF	Bourns ⁽⁹⁾	POT 100kΩ 3/8" SQ CERM SL ST	1
U1	MIC3202YM	Micrel, Inc. ⁽¹⁰⁾	High Brightness LED Driver with High-Side Current Sense	1
U2	MIC1557YM5	Micrel, Inc. ⁽¹⁰⁾	RC Time/Oscillator (SOT-23-5)	1

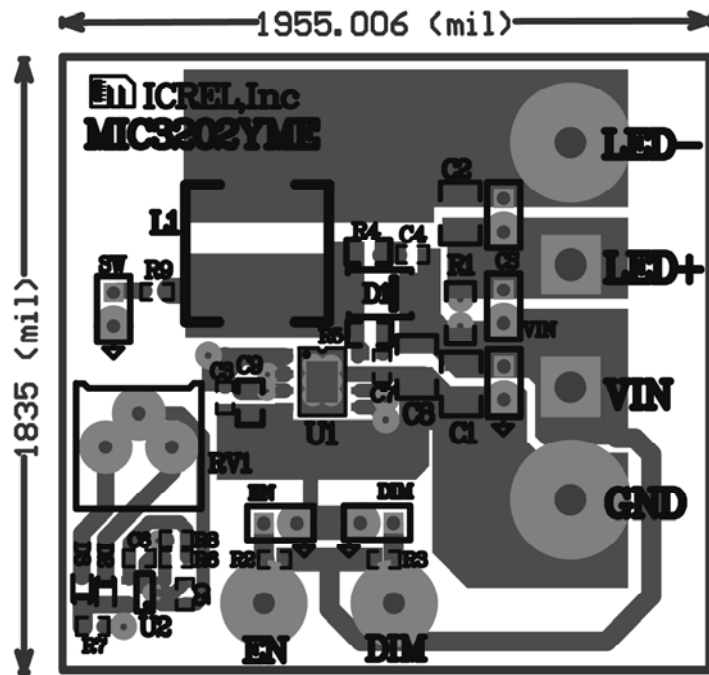
Notes:

1. AVX: www.avx.com.
2. Murata: www.murata.com.
3. TDK: www.tdk.com.
4. MCC: www.mccsemi.com.
5. Fairchild: www.fairchildsemi.com.
6. Diodes Inc. : www.diodes.com.
7. Stackpole Electronics: www.seielect.com.
8. Vishay: www.vishay.com.
9. Bourns Inc : www.bourns.com.
10. Micrel, Inc.: www.micrel.com.

PCB Layout Recommendation

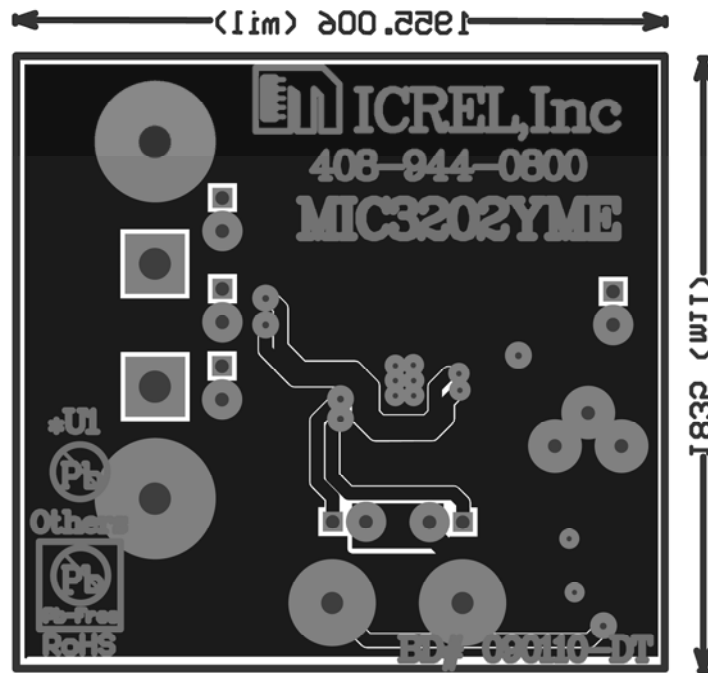


Top Assembly



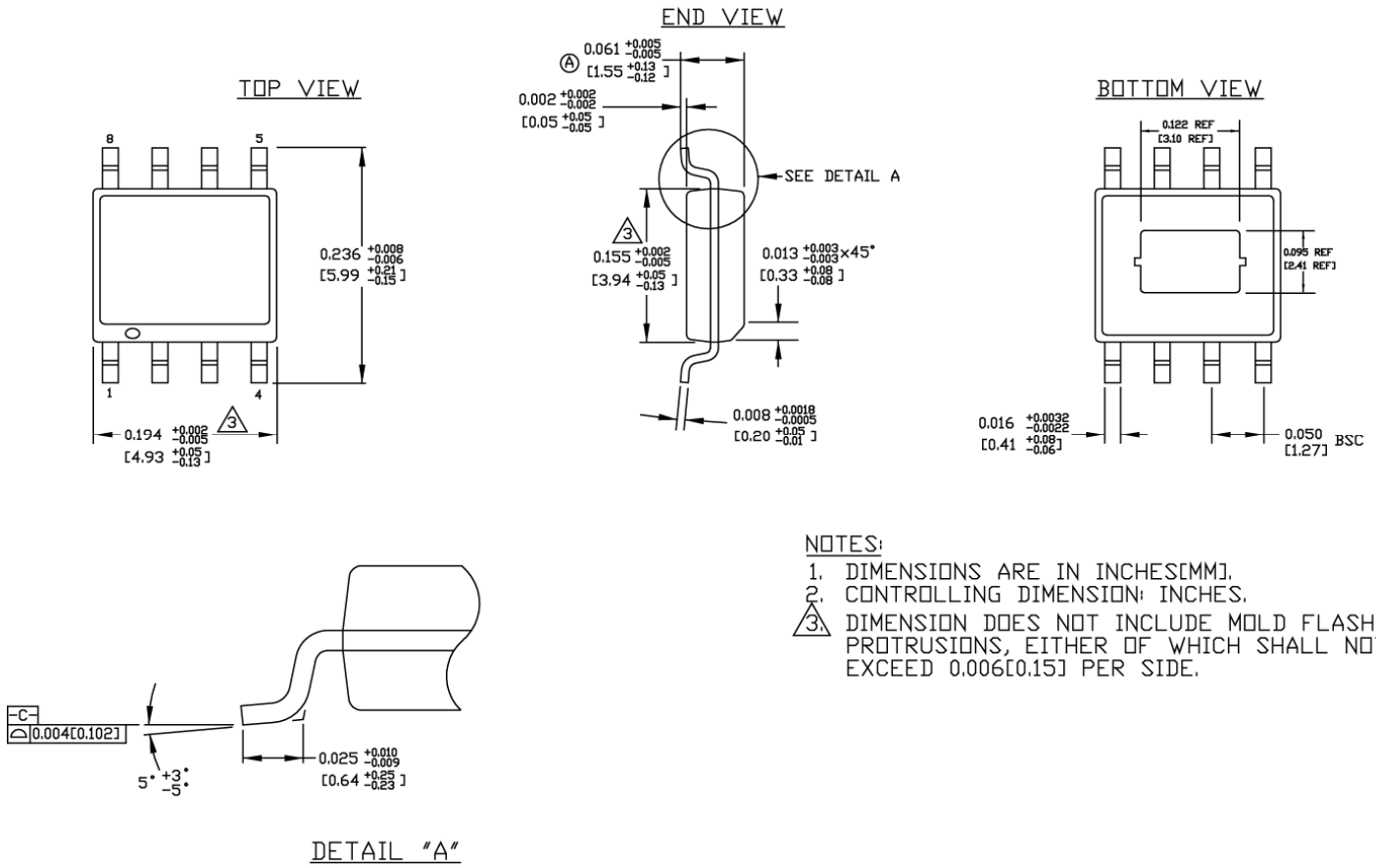
Top Layer

PCB Layout Recommendation (Continued)



Bottom Layer

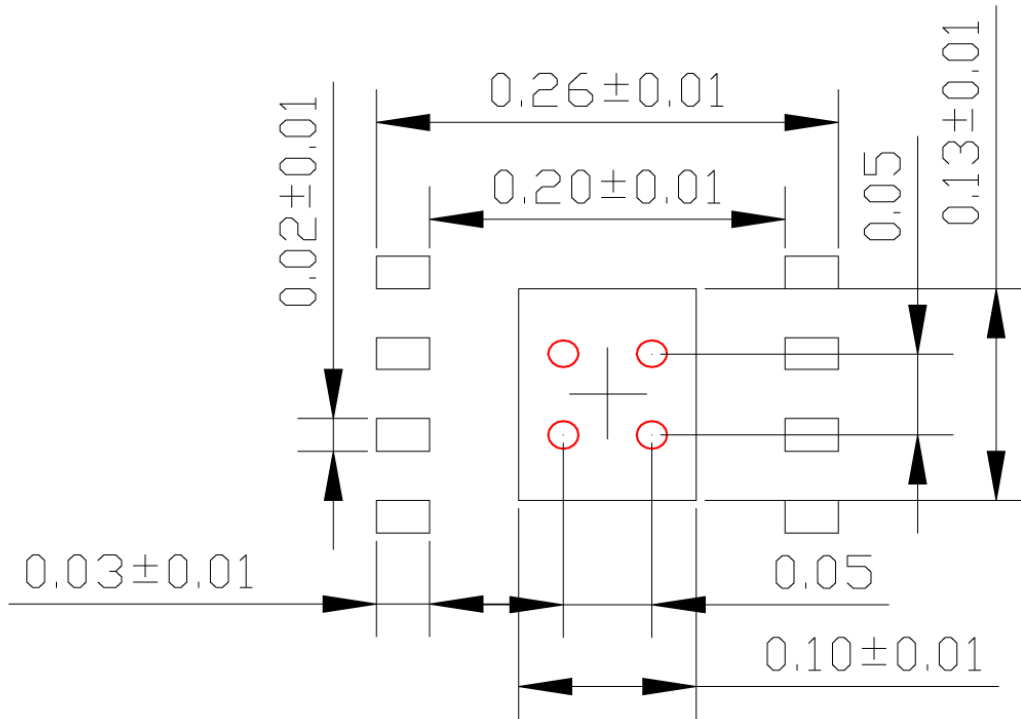
Package Information



8-Pin ePAD SOIC (ME)

Recommended Landing Pattern

LP # SOICNEP-8LD-LP-1
 All units are in inches
 Tolerance ± 0.05 if not noted



Red circle indicates Thermal Via. Size should be .015-.017 inches in diameter and it should be connected to GND plane for maximum thermal performance.

8-Pin ePAD SOIC (ME)

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA
 TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB <http://www.micrel.com>

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